

SSM6J23FE-VB Datasheet P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)		
- 30	0.032 at V _{GS} = - 10 V	-2.4	5.1 nC		
	0.042 at $V_{GS} = -4.5 \text{ V}$	- 2.0	3.1110		

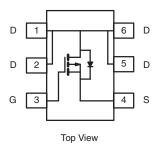
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- Trench Power MOSFET

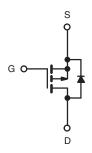
COMPLIANT HALOGEN FREE

APPLICATIONS





SC-75A(6-LEADS)



P-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 30	V	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		- 2.4		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	1 .	- 2.1		
Continuous Diain Current (1) = 130 °C)	T _A = 25 °C	- I _D	- 2.1 ^{b, c}		
	T _A = 70 °C		- 1.8 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	- 20		
Continuous Source-Drain Diode Current	T _C = 25 °C		- 2.5		
	T _A = 25 °C	I _S	- 1.67 ^{b, c}		
Maximum Power Dissipation	T _C = 25 °C		2.0		
	T _C = 70 °C		1.0	١٨/	
	T _A = 25 °C	P _D	1.3 ^{b, c}	W	
	T _A = 70 °C		0.8 ^{b, c}		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R_{thJA}	55	62.5	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	34	41	C/ V V	

Notes:

- a. Based on T_C = 25 °C.
 b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under Steady State conditions is 110 °C/W.

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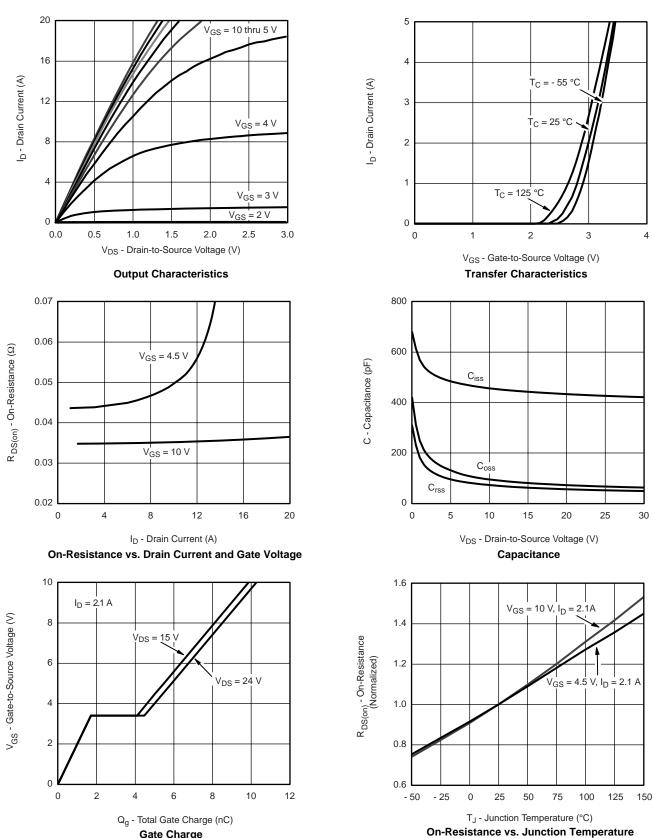
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 250 A		- 31		1400
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = -2500 \text{uA}$		4.5		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.0		- 3.0	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V			- 1	μΑ
		V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C			- 10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 20			Α
		V _{GS} = - 10 V, I _D = - 2.1 A		0.032		Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 1.0 A		0.042		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 2.1 A		8		S
Dynamic ^b						
Input Capacitance	C _{iss}			450		
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		80		pF
Reverse Transfer Capacitance	C _{rss}			63		
T. (10) O		V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 2.1 A		10	15	nC
Total Gate Charge	Q_g			5.1	8	
Gate-Source Charge	Q _{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -2.1 \text{ A}$		1.8		
Gate-Drain Charge	Q _{gd}			2.5		
Gate Resistance	R_{g}	f = 1 MHz		7		Ω
Turn-On Delay Time	t _{d(on)}			40	60	ns
Rise Time	t _r	V_{DD} = - 15 V, R_{L} = 4.6 Ω		80	120	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 3.3 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		20	30	
Fall Time	t _f			12	20	
Turn-On Delay Time	t _{d(on)}			5	10	
Rise Time	t _r	V_{DD} = - 15 V, R_L = 4.6 Ω		13	20	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 3.3 A, V_{GEN} = - 10 V, R_g = 1 Ω		20	30	
Fall Time	t _f			10	15	
Drain-Source Body Diode Characteristic	cs					
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 2.5	
Pulse Diode Forward Current ^a	I _{SM}				- 20	A
Body Diode Voltage	V _{SD}	I _S = - 3.3 A		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t _{rr}			20	30	ns
Body Diode Reverse Recovery Charge	Q _{rr}			20	30	nC
Reverse Recovery Fall Time	t _a	$I_F = -3.3 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		14		
Reverse Recovery Rise Time	t _b	\dashv		6		ns

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 % b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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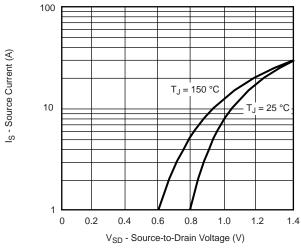


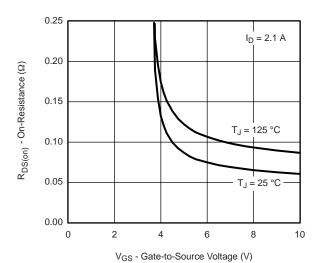


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Gate Charge

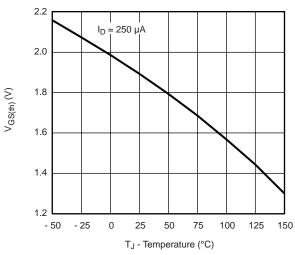


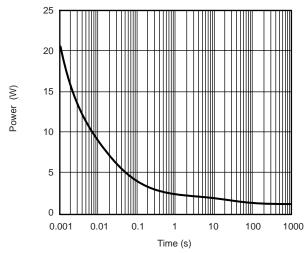




Source-Drain Diode Forward Voltage

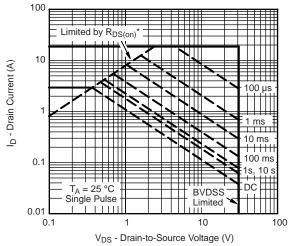






Threshold Voltage

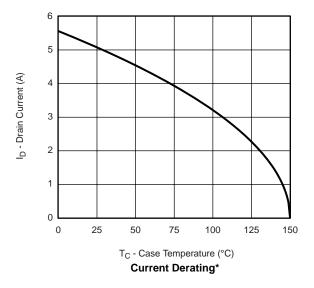
Single Pulse Power

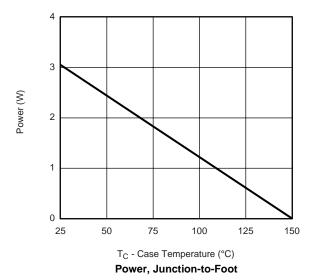


* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area



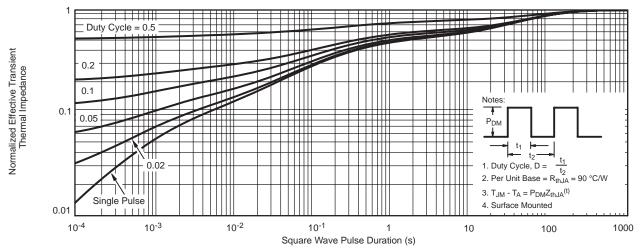




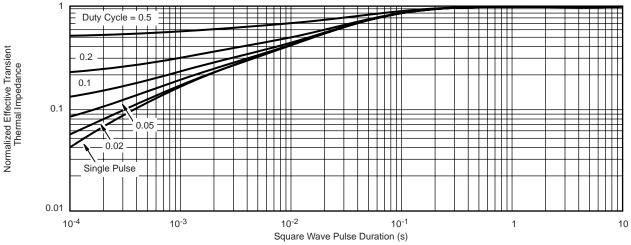
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^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



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